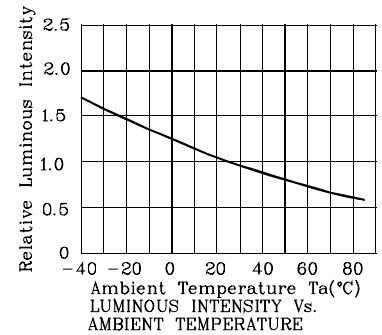
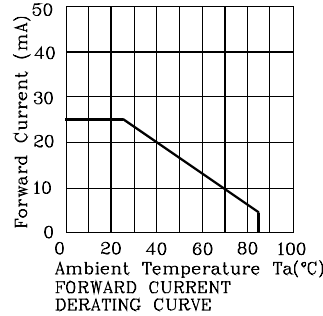
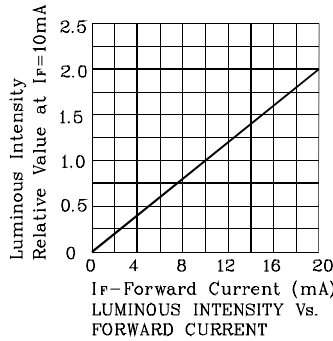
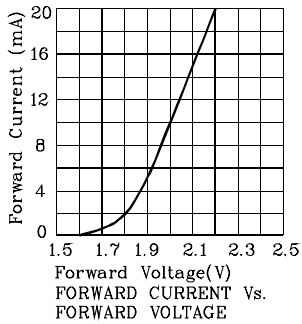


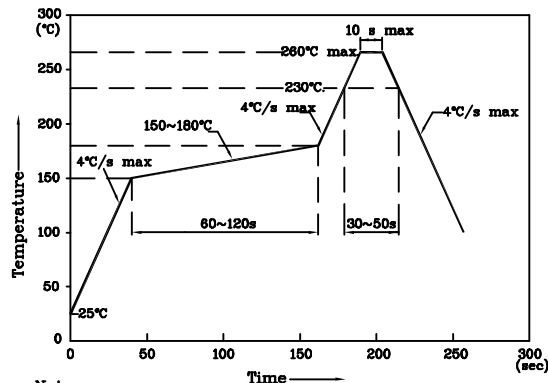
RELATIVE INTENSITY Vs. WAVELENGTH

❖ MG



**LED is recommended for reflow soldering and soldering profile is shown below.**

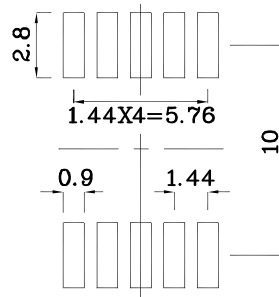
**Reflow Soldering Profile for SMD Products (Pb-Free Components)**



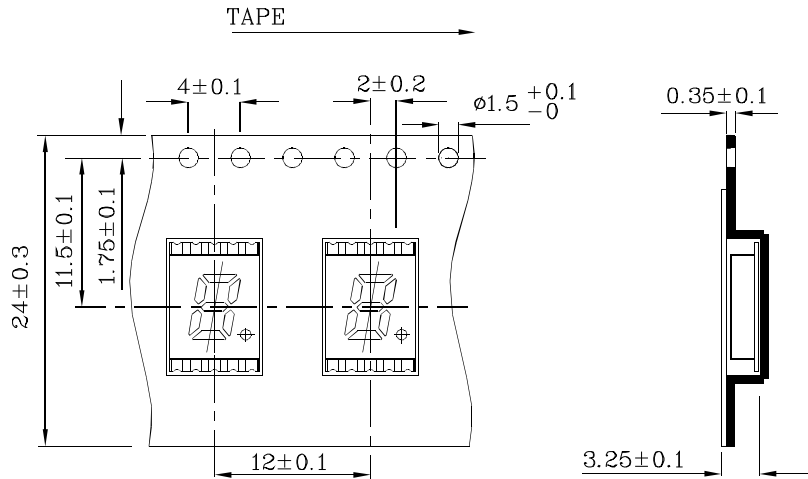
- Notes:
1. Maximum soldering temperature should not exceed 280°C
  2. Recommended reflow temperature: 145°C-280°C
  3. Do not put stress to the epoxy resin during high temperatures conditions



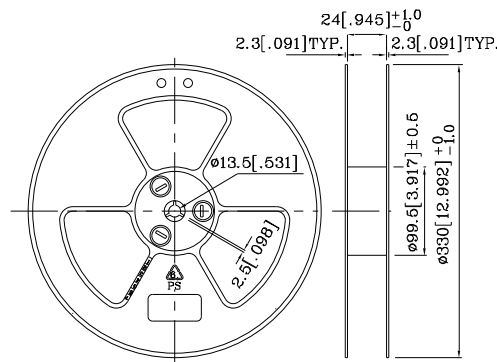
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ±0.15)



❖ Tape Specification (Units : mm)



❖ Reel Dimension



Remarks:

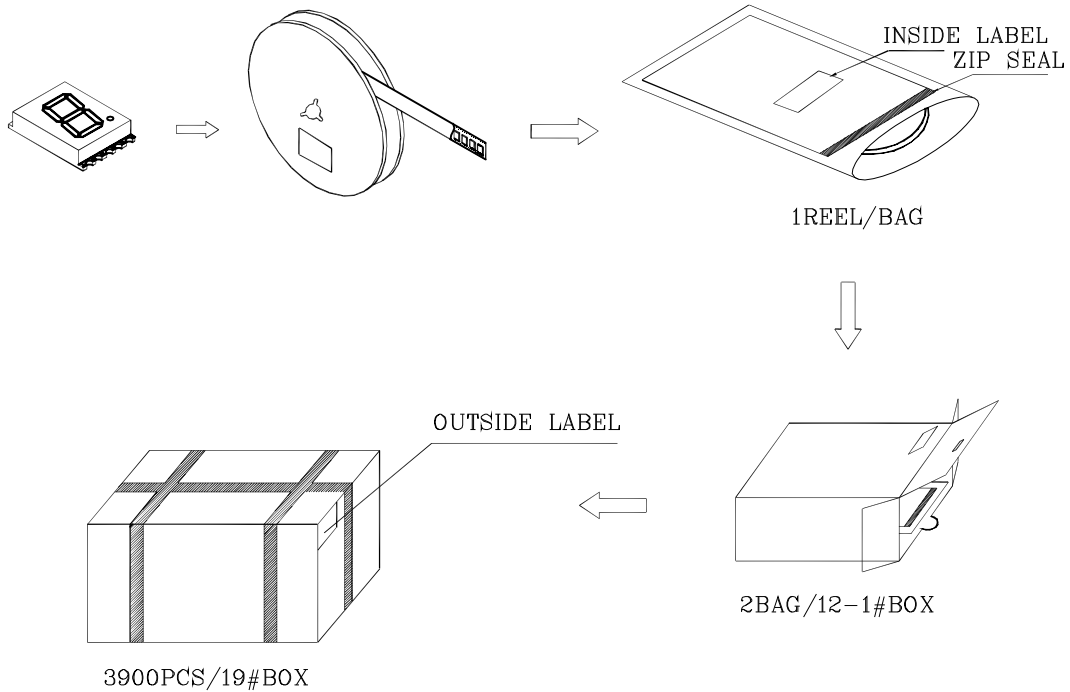
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

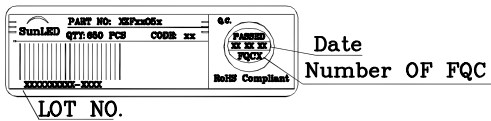
Note: Accuracy may depend on the sorting parameters.



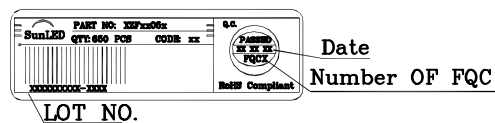
PACKING & LABEL SPECIFICATIONS



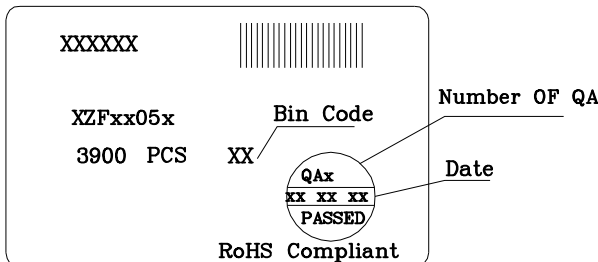
Inside Label On tape



Outside Label On Bag



Outside Label On 19#Box



Outside Label On 12-1#Box

